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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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# RENESAS

# MOS FIELD EFFECT TRANSISTOR $\mu PA1830$

### P-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

#### DESCRIPTION

The  $\mu$ PA1830 is a switching device which can be driven directly by a 4.0 V power source.

This device features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power management of notebook computers and so on.

#### FEATURES

- 4.0 V drive available
- Low on-state resistance  $R_{DS(on)1} = 17 \ m\Omega \ MAX. \ (V_{GS} = -10 \ V, \ I_{D} = -4.5 \ A)$   $R_{DS(on)2} = 24.5 \ m\Omega \ MAX. \ (V_{GS} = -4.5 \ V, \ I_{D} = -4.5 \ A)$  $R_{DS(on)3} = 28 \ m\Omega \ MAX. \ (V_{GS} = -4.0 \ V, \ I_{D} = -4.5 \ A)$
- Built-in G-S protection diode against ESD

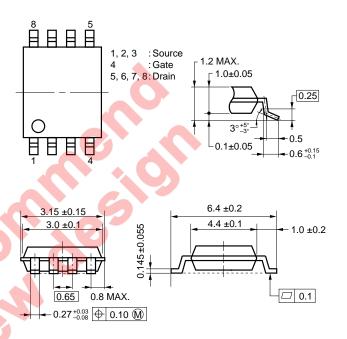
#### ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA1830GR-9JG	Power TSSOP8

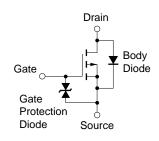
#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vcs = 0 V)	VDSS	-30	V
Gate to Source Voltage (Vps = 0 V)	Vgss	∓20	V
Drain Current (DC) (T <sub>A</sub> = 25°C)	ID(DC)	∓9.0	Α
Drain Current (pulse) Note1	D(pulse)	∓36	А
Total Power Dissipation Note2	P⊤	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C

#### PACKAGE DRAWING (Unit: mm)



#### EQUIVALENT CIRCUIT



**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

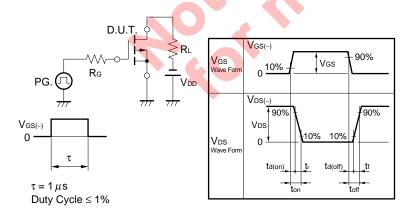
- 2. Mounted on ceramic substrate of 5000 mm<sup>2</sup> x 1.1 mm
- **Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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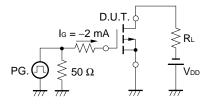
**ELECTRICAL CHARACTERISTICS (TA = 25°C)** 

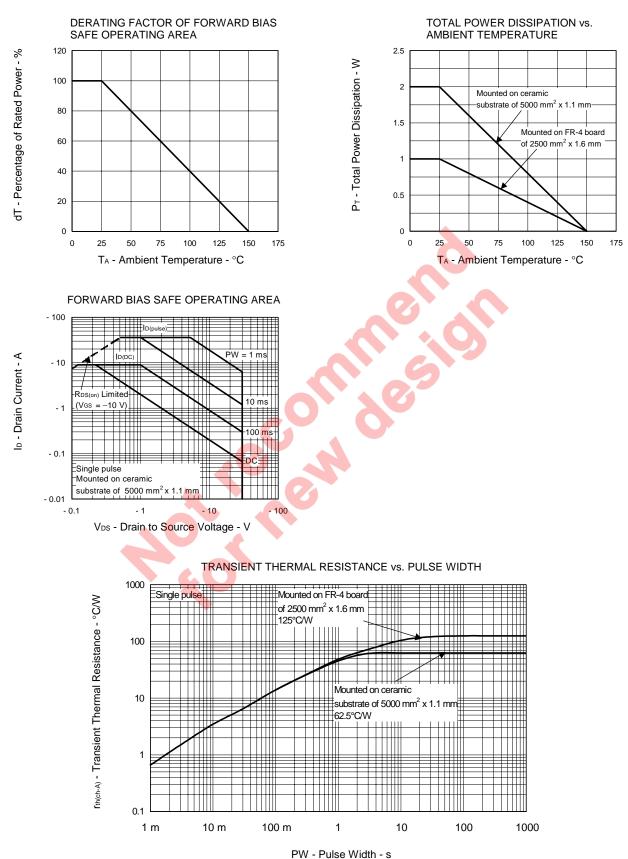
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Idss	$V_{DS} = -30 V, V_{GS} = 0 V$			-1.0	μA
Gate Leakage Current	lgss	Vgs = ∓20 V, Vds = 0 V			<b>∓10</b>	μA
Gate Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -1.0 mA	-1.0	-2.0	-2.5	V
Forward Transfer Admittance	yfs	$V_{DS} = -10 \text{ V}, \text{ Id} = -4.5 \text{ A}$	8.0	17.4		S
Drain to Source On-state Resistance	RDS(on)1	Vgs = −10 V, Id = −4.5 A		13.7	17	mΩ
	RDS(on)2	Vgs = −4.5 V, Ib = −4.5 A		18.5	24.5	mΩ
	RDS(on)3	$V_{GS} = -4.0 \text{ V}, \text{ ID} = -4.5 \text{ A}$		21	28	mΩ
Input Capacitance	Ciss	$V_{DS} = -10 V$		1950		pF
Output Capacitance	Coss	Vgs = 0 V		570		pF
Reverse Transfer Capacitance	Crss	f = 1.0 MHz		350		pF
Turn-on Delay Time	td(on)	Vdd = -15 V, Id = -4.5 A		17		ns
Rise Time	tr	V <sub>GS</sub> = -10 V		16		ns
Turn-off Delay Time	td(off)	R <sub>G</sub> = 10 Ω		140		ns
Fall Time	tr			150		ns
Total Gate Charge	QG	$V_{DD} = -24 V$		38		nC
Gate to Source Charge	QGS	Vgs = -10 V		4.5		nC
Gate to Drain Charge	Qgd	I⊳ = −9.0 A		12		nC
Body Diode Forward Voltage	VF(S-D)	IF = 9.0 A, Vgs = 0 V		0.84		V
Reverse Recovery Time	trr	I⊧ = 9.0 A, V₀s = 0 V		60		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/µs		40		nC

#### TEST CIRCUIT 1 SWITCHING TIME



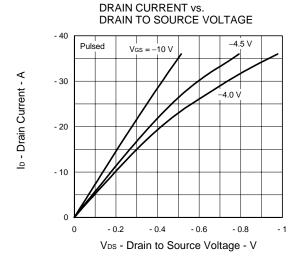
#### TEST CIRCUIT 2 GATE CHARGE

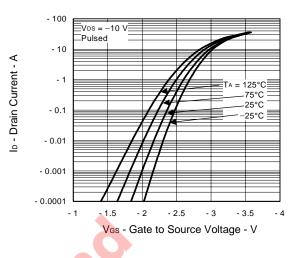




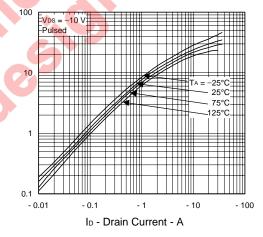




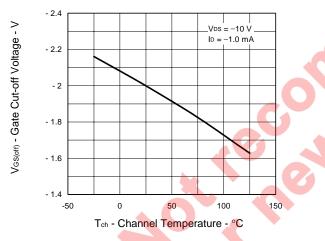




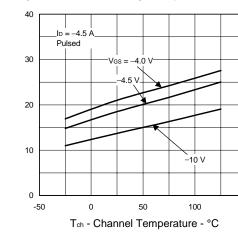
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



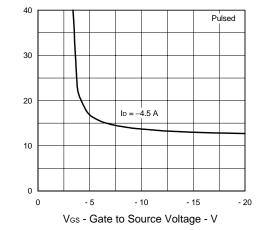




DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



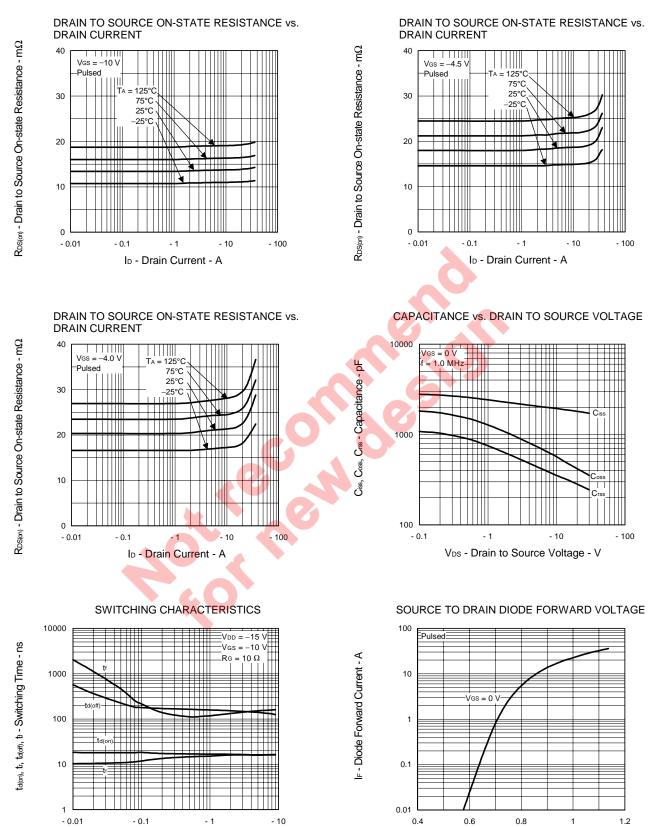
150

S

| yis | - Forward Transfer Admittance -

 $R_{\text{DS}(\text{on})}$  - Drain to Source On-state Resistance -  $m\Omega$ 

 $R_{\text{DS}(\text{on})}$  - Drain to Source On-state Resistance -  $m\Omega$ 

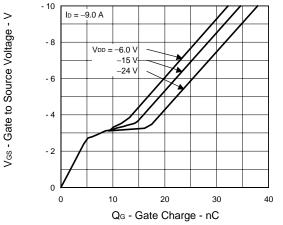


V<sub>F(S-D)</sub> - Source to Drain Voltage - V

Data Sheet G16268EJ1V0DS

ID - Drain Current - A

DYNAMIC INPUT/OUTPUT CHARACTERISTICS



[MEMO]



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